

■ Features

- 2.5A Absolute Maximum Peak Output Current
- 15 kV/ μ s minimum Common Mode Rejection (CMR) at VCM = 1500 V
- 0.5 V maximum low level output voltage (VOL)
- ICC = 2.5mA maximum supply current
- Under Voltage Lock-Out protection (UVLO) with hysteresis
- Wide operating VCC range: 15 to 30 V
- 400 ns maximum switching speeds
- Industrial temperature range: -40°C to 110°C

■ Applications

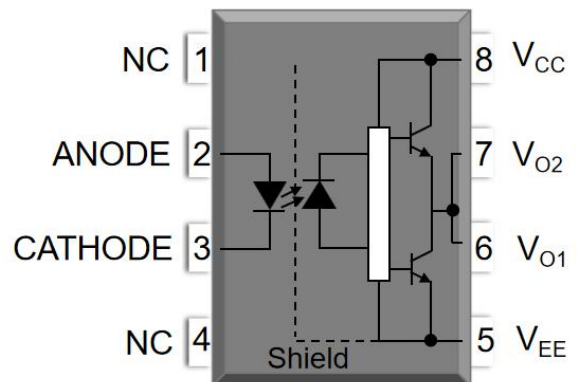
- IGBT/MOSFET gate drive
- Inverter for Home Appliances
- Industrial Inverters
- Switching Power Supplies (SPS)

■ Description

The MP350A is a photo coupler in a DIP8 package that consists of a GaAlAs infrared light-emitting diode (LED) optically coupled to an integrated high-gain, high-speed photodetector IC chip. It provides guaranteed performance and specifications at temperatures up to 100°C.

The MP350A has an internal Faraday shield that provides a guaranteed Common-mode transient immunity of ± 15 kV/ μ s. It has a totem-pole output that can both sink and source current. The MP350A is ideal for IGBT of small capacity to middle capacity and power MOSFET gate drive.

■ Schematic





MP350A Series

DIP8, DC Input, 2.5A, Gate Driver Photo Coupler

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT	Note
INPUT				
Forward Current	IF	20	mA	
Peak Forward Current	IFP	50	mA	1
Peak Transient Current	IF(trans)	1	A	2
Operating Frequency	f	50	kHz	
Reverse Voltage	VR	5	V	
Input Power Dissipation	PD	40	mW	
OUTPUT				
Supply Voltage	VCC	35	V	
Output Voltage	VO	35	V	
Peak Output Current	IO	2.5	A	
Output Power Dissipation	PO	260	mW	
COMMON				
Total Power Dissipation	Ptot	300	mW	
Isolation Voltage	Viso	5000	Vrms	3
Operating Temperature	Topr	-40~110	°C	
Storage Temperature	Tstg	-55~125	°C	
Soldering Temperature	Tsol	260	°C	4

Note 1. 50% duty, 1ms P.W

Note 2. $\leq 1\mu\text{s}$ P.W, 300pps

Note 3. AC For 1 Minute, R.H. = 40 ~ 60%

Note 4. For 10 seconds

TRUTH TABLE

LED	VCC-VEE "Positive Going" (Turn-on)	VCC-VEE "Negative Going" (Turn-off)	VO
Off	0V to 30V	0V to 30V	Low
On	0V to 11V	0V to 9.5V	Low
On	11V to 13.5V	9.5V to 12V	Transition
On	13.5V to 30V	12V to 30V	High



MP350A Series

DIP8, DC Input, 2.5A, Gate Driver Photo Coupler

RECOMMENDED OPERATION CONDITIONS

PARAMETER	SYMBOL	MIN.	MA.	UNIT
Operating Temperature	TA	-40	100	°C
Supply Voltage	VCC	15	30	V
Input Current (ON)	IF(ON)	7	16	mA
Input Voltage (OFF)	VF(OFF)	0	0.8	V

ELECTRICAL OPTICAL CHARACTERISTICS (VCC=30V, VEE=GND, TA=25°C unless specified otherwise)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE
INPUT CHARACTERISTICS							
Forward Voltage	VF	-	1.35	1.9	V	IF=10mA	
Reverse Current	IR	-	-	10	μA	VR=5V	
Input Threshold Current	IFLH	-	2.6	5.0	mA	IO=0mA, VO>5V	
Input Threshold Voltage	VFHL	0.8	1.3	-	V	IO=0mA, VO<5V	
Input Capacitance	Cin	-	1.0	-	pF	VF=0V, f=1MHz	
OUTPUT CHARACTERISTICS							
High Level Supply Current	ICCH	-	1.7	2.5	mA	IF= 10mA, VO= Open	
Low Level Supply Current	ICCL	-	1.3	2.5	mA	IF= 0mA, VO= Open	
High Level Output Voltage	VOH	VCC-4.0	VCC-2.1	-	V	IF=10mA, IO=-100mA	
Low Level Output Voltage	VOL	-	0.21	0.5	V	IF=0mA, IO=100mA	
High Level Output Current	IOH	-	-2.2	-1.0	A	VO=VCC-4V	1
		-	-	-2.0	A	VO=VCC-15V	2
Low Level Output Current	IOL	1.0	1.4	-	A	VO=VEE+2.5V	1
		2.0	-	-	A	VO=VEE+15V	2
Under Voltage Lockout Threshold	VUVLO+	11	12.5	13.5	V	IO= 10mA, VO> 5V	
	VUVLO-	9.5	10.6	12	V	IO= 10mA, VO< 5V	
Isolation Resistance	Riso	10 ¹²	10 ¹⁴	-	Ω	DC500V, 40 ~ 60% R.H.	

Note1. Maximum pulse width = 50μs.

Note2. Maximum pulse width = 10μs.



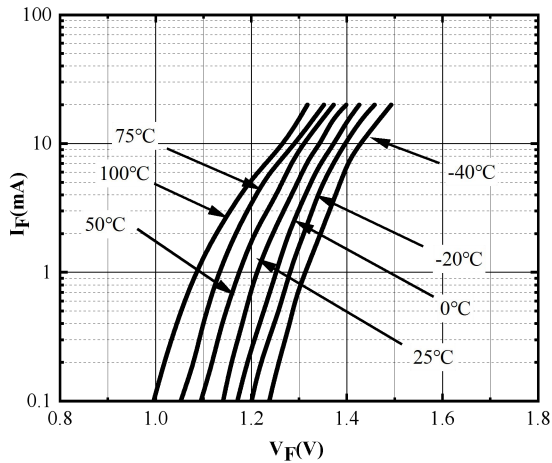
MP350A Series

DIP8, DC Input, 2.5A, Gate Driver Photo Coupler

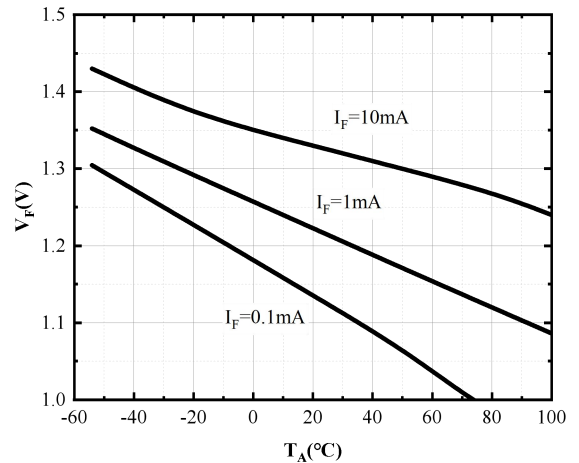
ELECTRICAL OPTICAL CHARACTERISTICS (VCC=30V, VEE=GND, TA=25°C unless specified otherwise)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE
SWITCHING CHARACTERISTICS							
Propagation Delay Time to Output Low Level	TPHL	50	186	400	ns	IF= 10mA, Cg= 10nF, Rg= 10Ω, f= 10kHz, Duty = 50%	
Propagation Delay Time to Output High Level	TPLH	50	154	400			
Pulse Width Distortion	PWD	-	32	200			
Rise Time	tr	-	30	-			
Fall Time	tf	-	20	-			
Common Mode Transient Immunity at Logic High	CMH	15	-	-	kV/μs	IF=10mA,VCC=30V, TA=25°C,VCM= 1.5kV	
Common Mode Transient Immunity at Logic Low	CML	15	-	-	kV/μs	VF=0V, VCC= 30V, TA= 25°C,VCM=1.5kV	

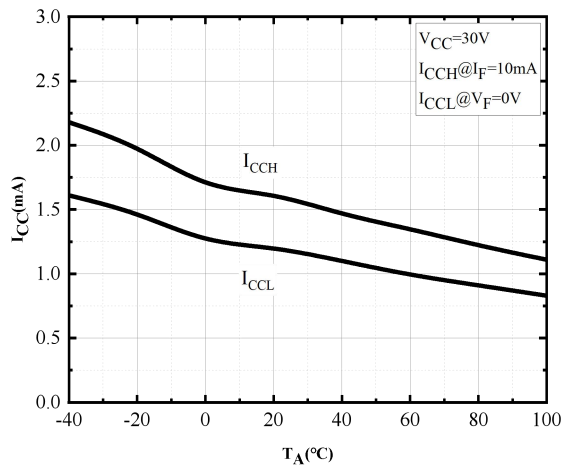
CHARACTERISTIC CURVES



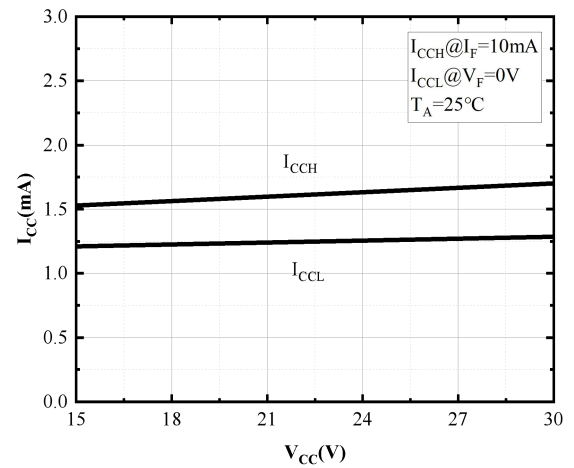
**Fig.1 Forward Current
vs. Forward Voltage**



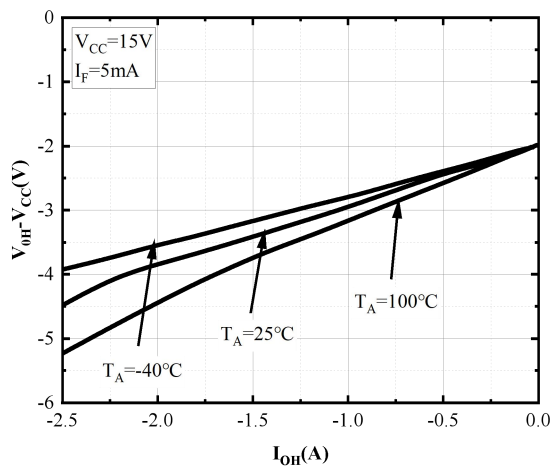
**Fig.2 Forward Voltage
vs. Ambient Temperature**



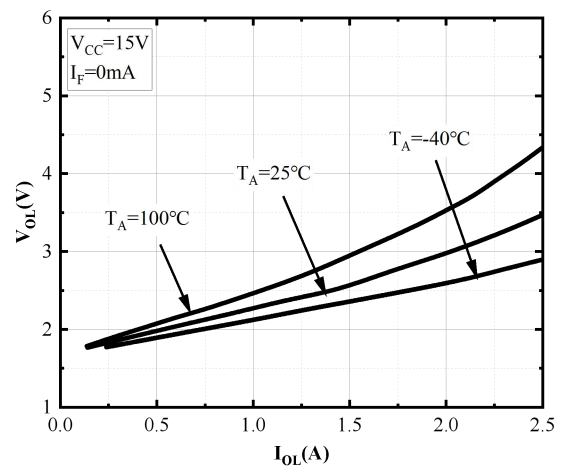
**Fig.3 Supply Current
vs. Ambient Temperature**



**Fig.4 Supply Current
vs. Supply Voltage**



**Fig.5 High Level Output Voltage
vs. High Level Output Current**



**Fig.6 Low Level Output Voltage
vs. Low Level Output Current**

CHARACTERISTIC CURVES

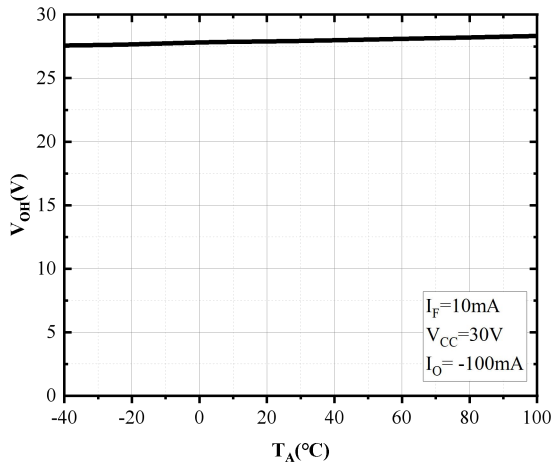


Fig.7 High Level Output Voltage vs. Ambient Temperature

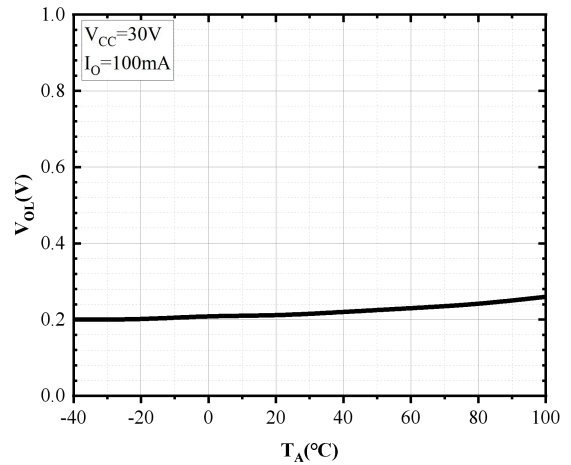


Fig.8 Low Level Output Voltage vs. Ambient Temperature

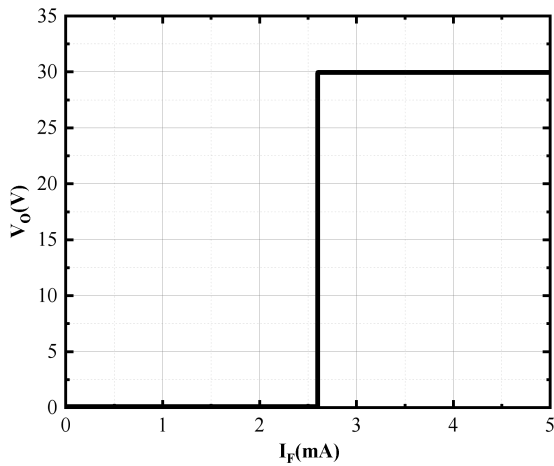


Fig.9 Output Voltage vs. Forward Current

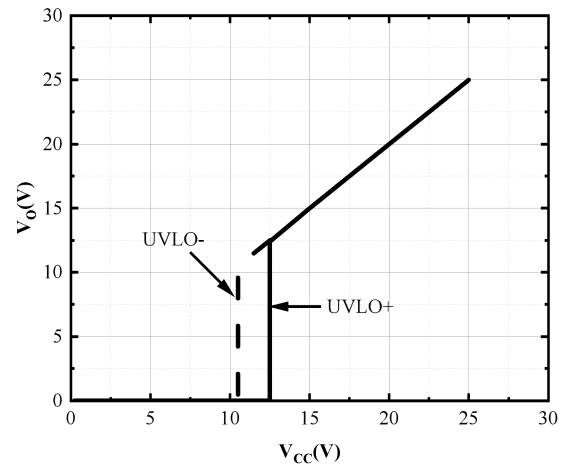


Fig.10 Output Voltage vs. Supply Voltage

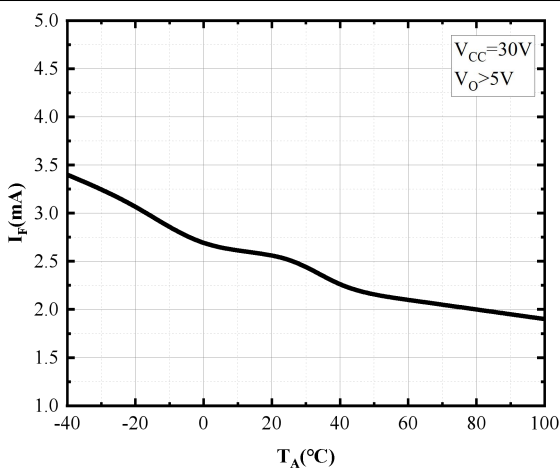


Fig.11 Forward Current vs. Ambient Temperature

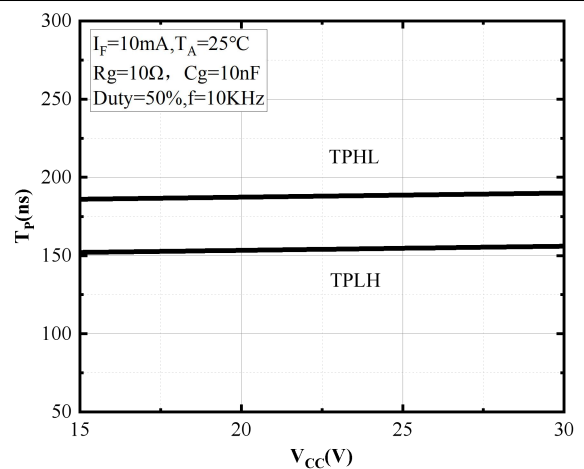
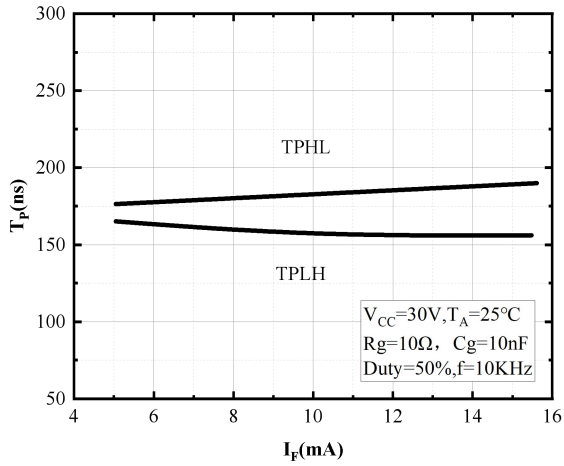
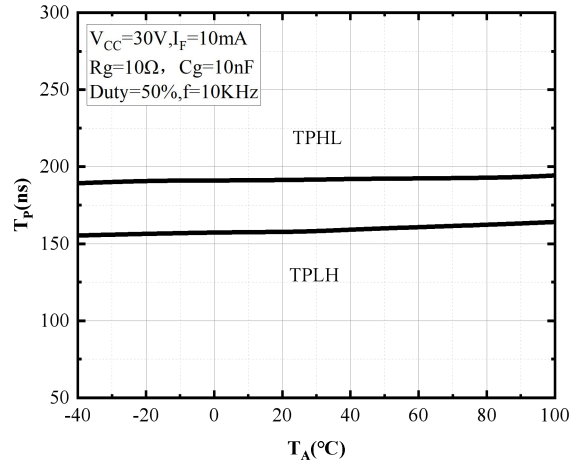


Fig.12 Propagation Delay vs. Supply Voltage

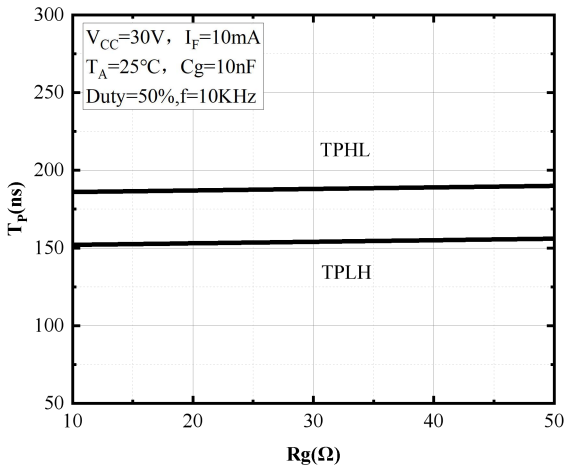
CHARACTERISTIC CURVES



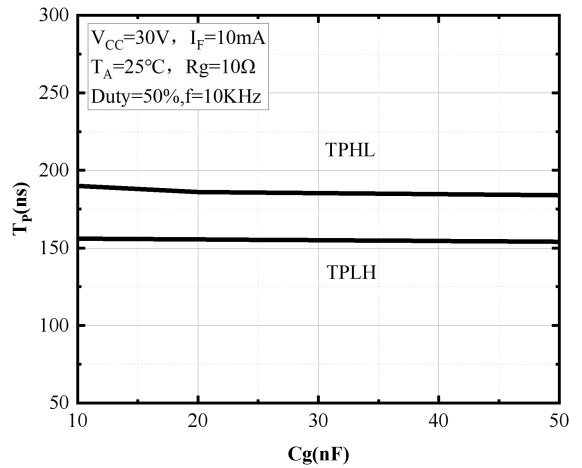
**Fig.13 Propagation Delay
vs. Forward Current**



**Fig.14 Propagation Delay
vs. Ambient Temperature**



**Fig.15 Propagation Delay
vs. Load Resistance**



**Fig.16 Propagation Delay
vs. Load Capacitance**

TEST CIRCUITS

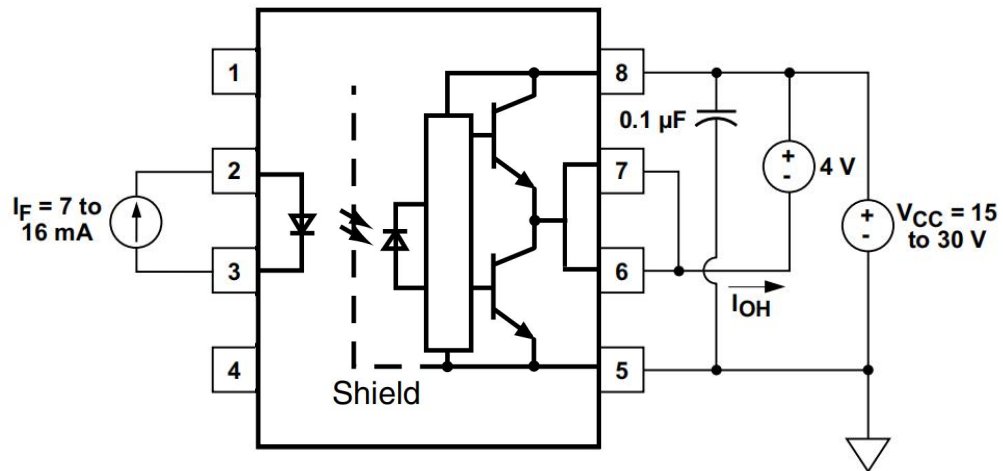


Fig.17 Test Circuits for I_{OH}

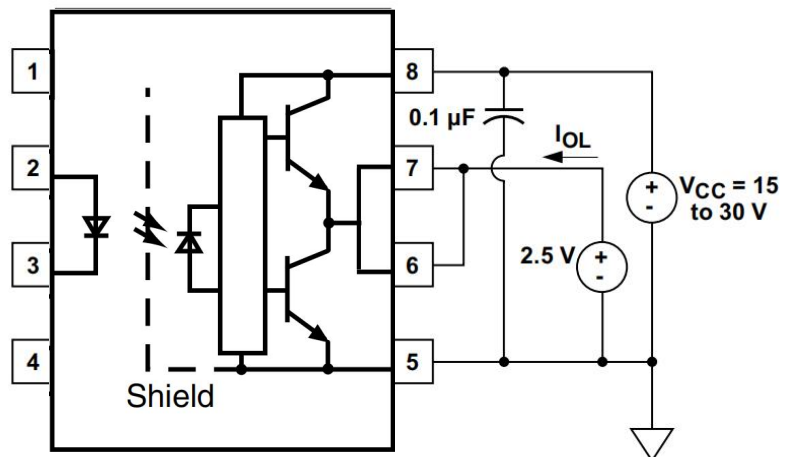


Fig.18 Test Circuits for I_{OL}

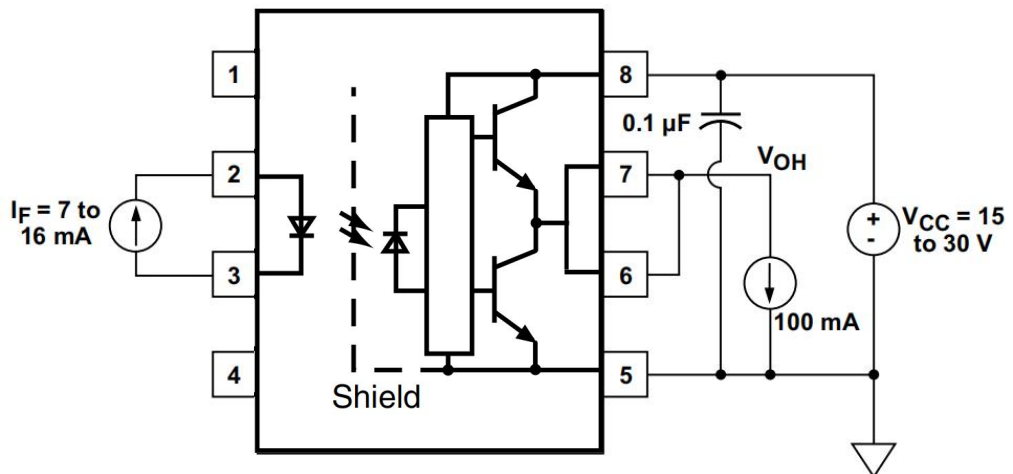


Fig.19 Test Circuits for V_{OH}

TEST CIRCUITS

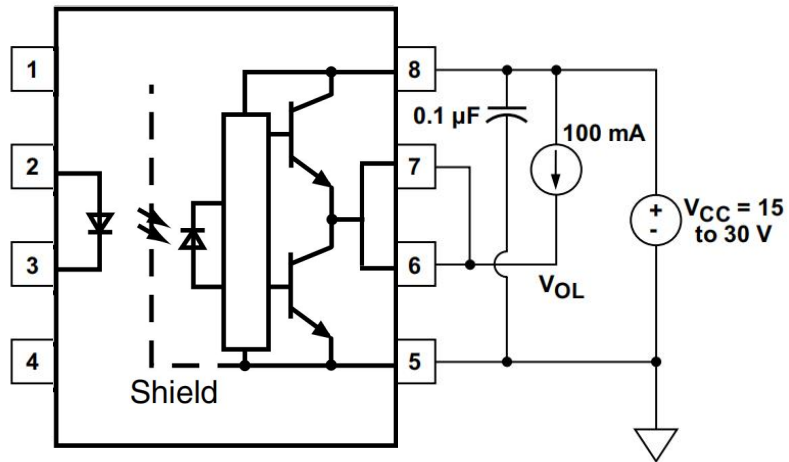


Fig.20 Test Circuits for V_{OL}

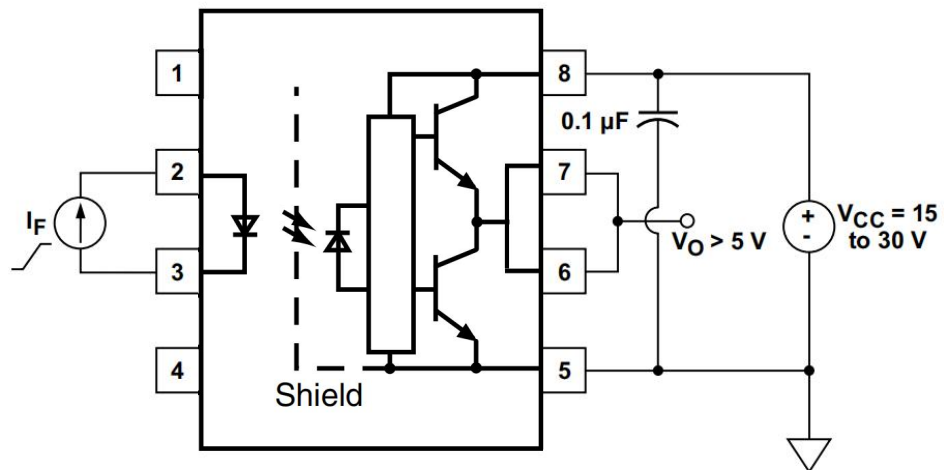


Fig.21 Test Circuits for I_{FLH}

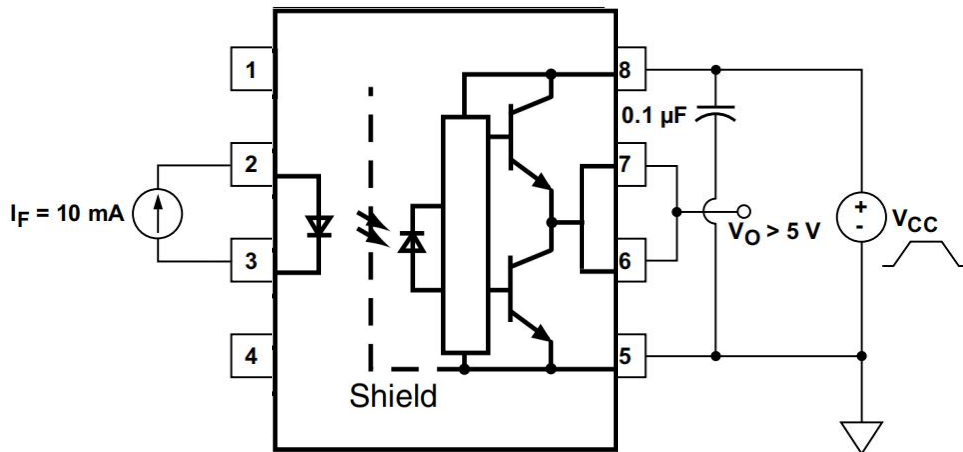


Fig.22 Test Circuits for $UVLO$

TEST CIRCUITS

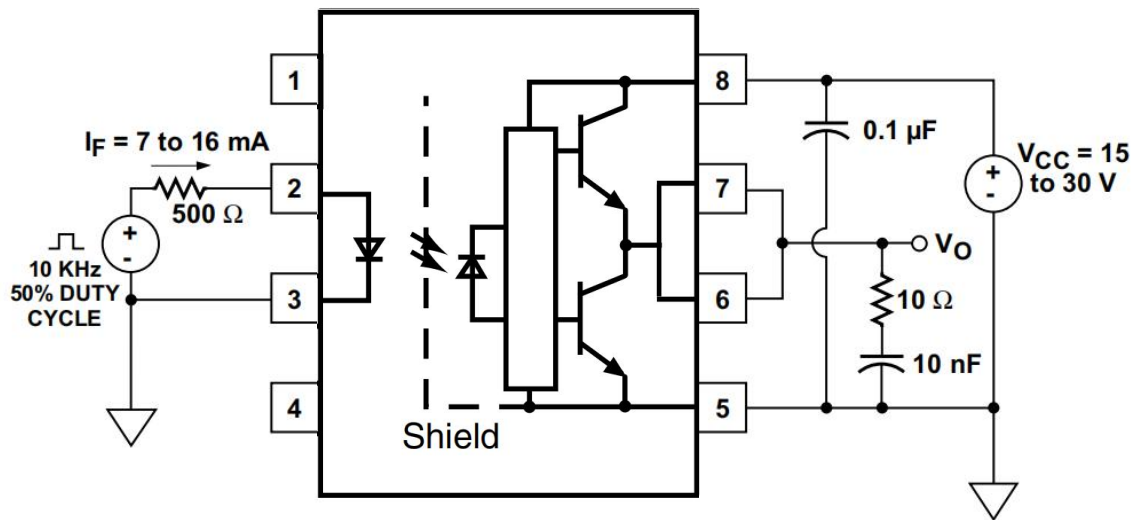


Fig.23 Test Circuits for TPHL, TPLH, tr, tf

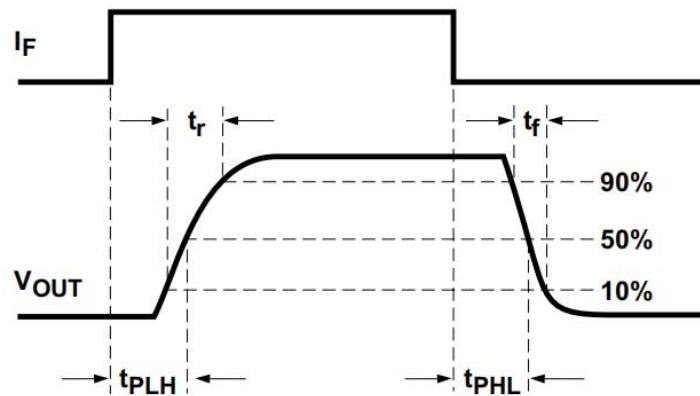


Fig.24 Wave forms of TPHL, TPLH, tr, tf

TEST CIRCUITS

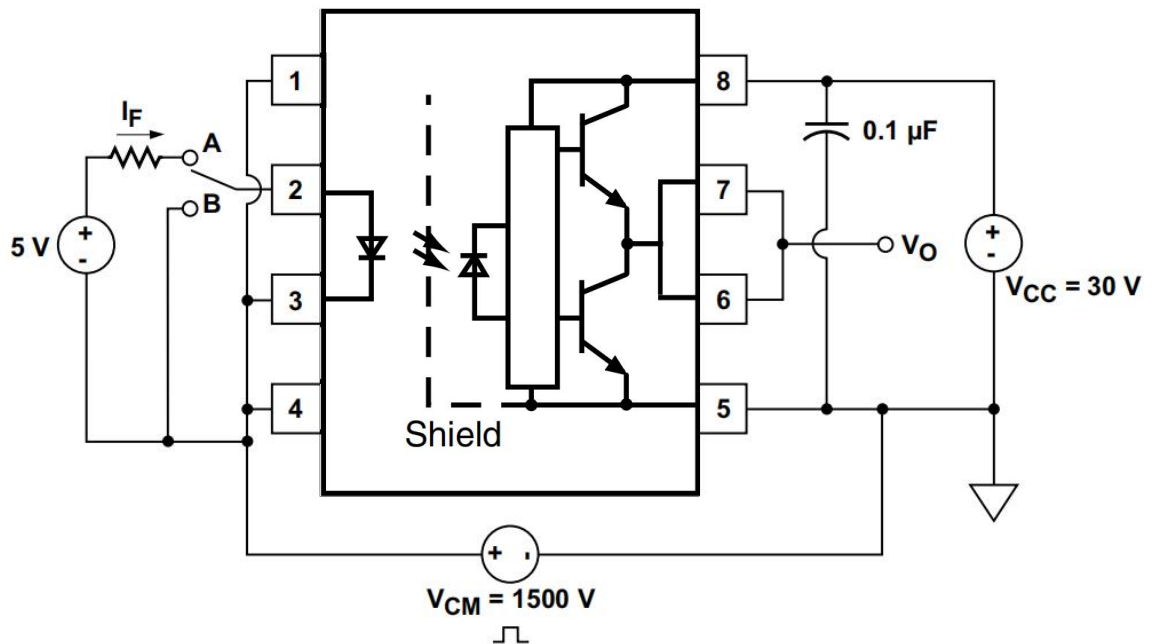


Fig.25 Test Circuits for Common Mode Transient Immunity

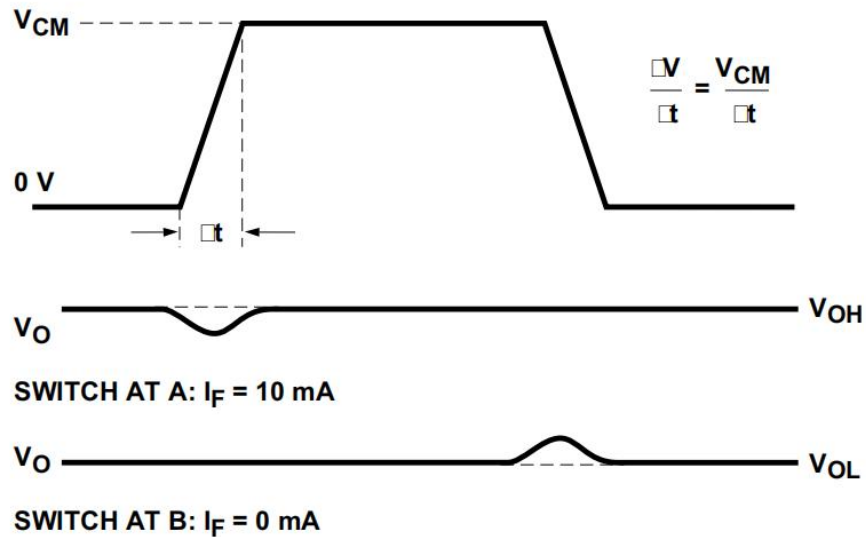
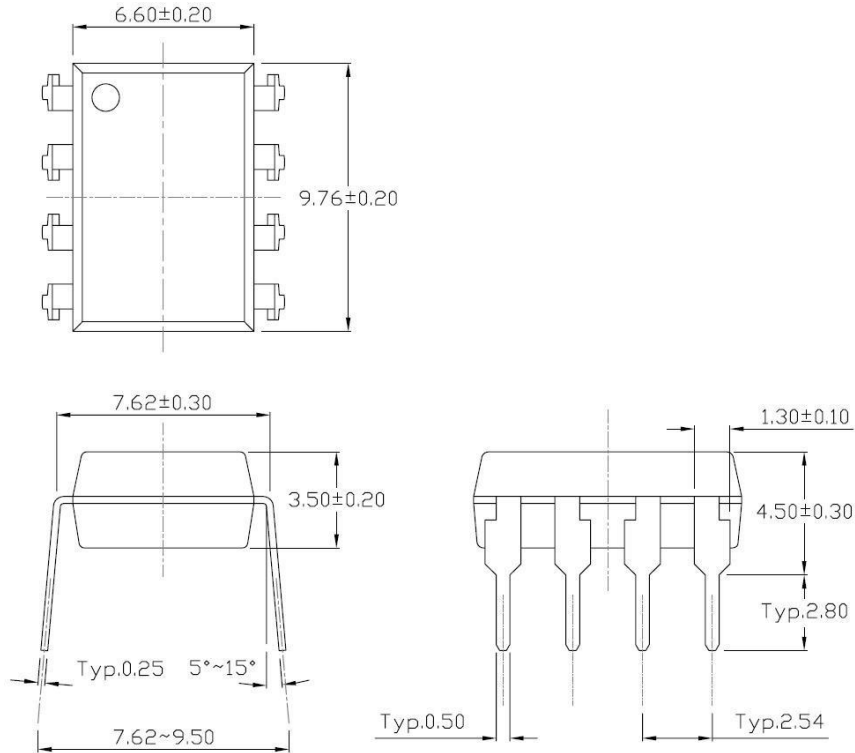


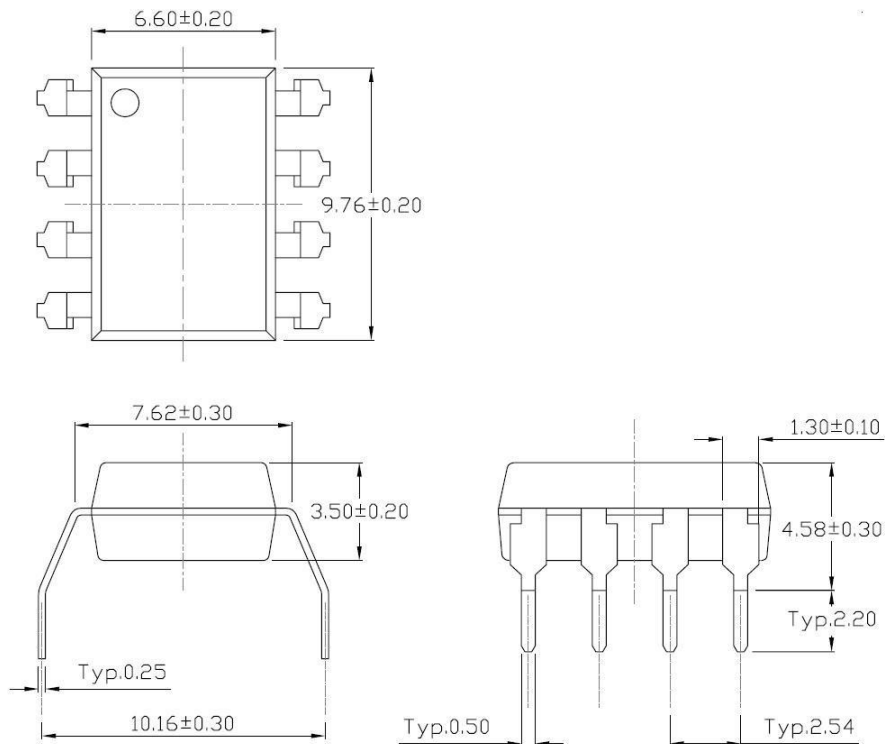
Fig.26 Waveforms of Common Mode Transient Immunity

PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Standard DIP – Through Hole (DIP Type)

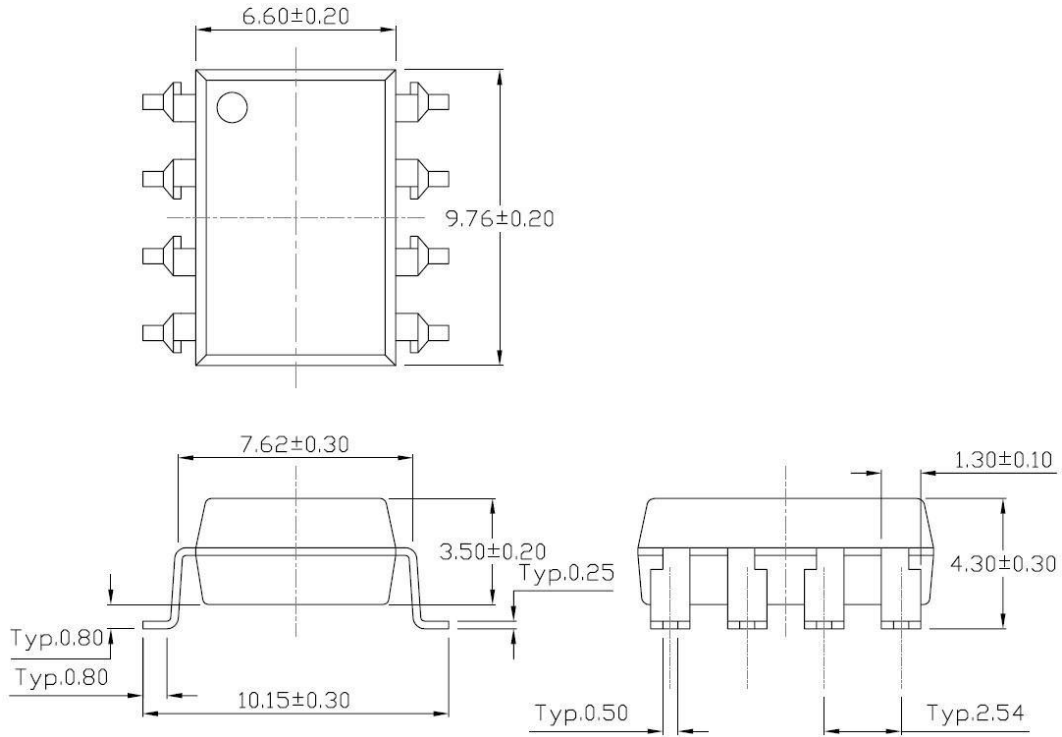


Gullwing (400mil) Lead Forming – Through Hole (M Type)

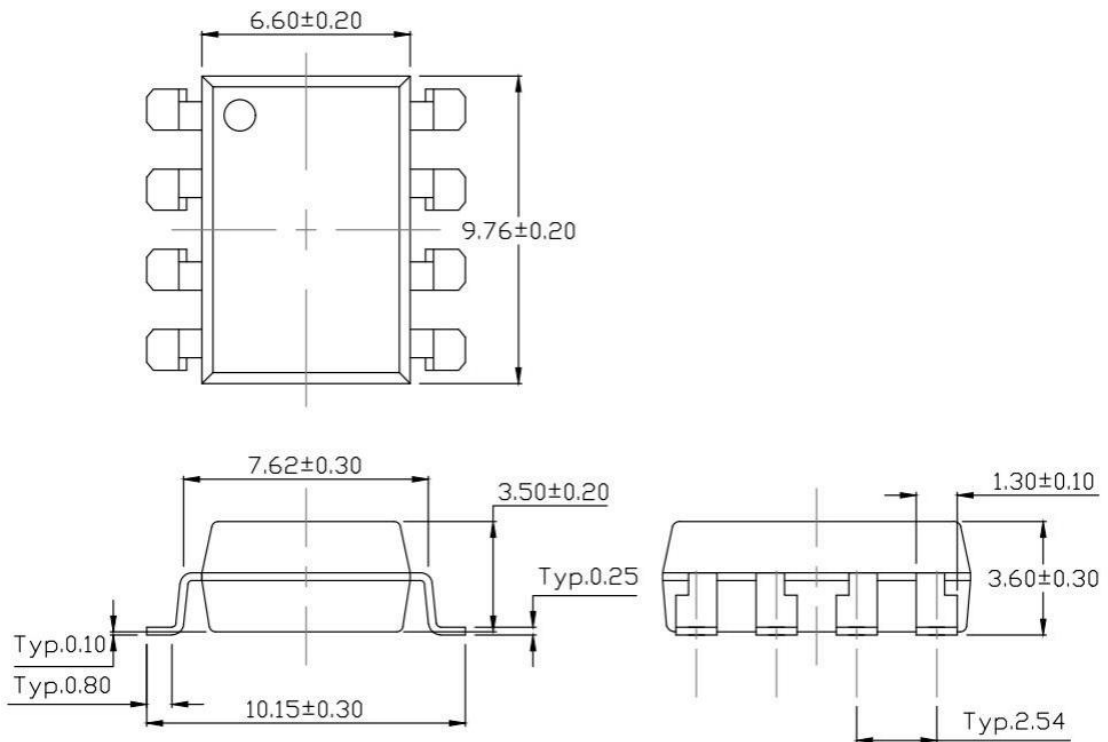


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming (S Type)

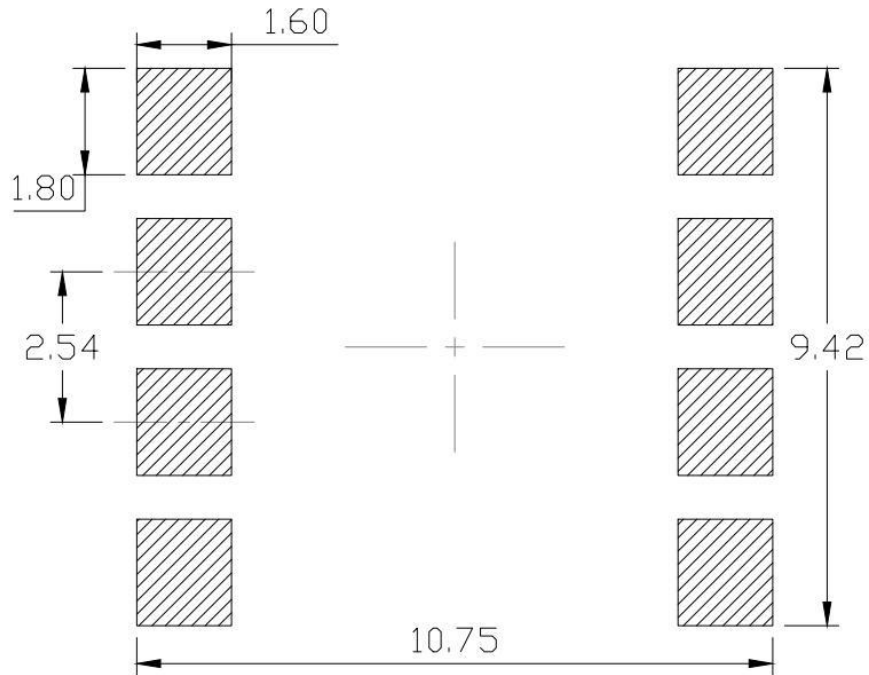


Surface Mount (Low Profile) Lead Forming (SL Type)

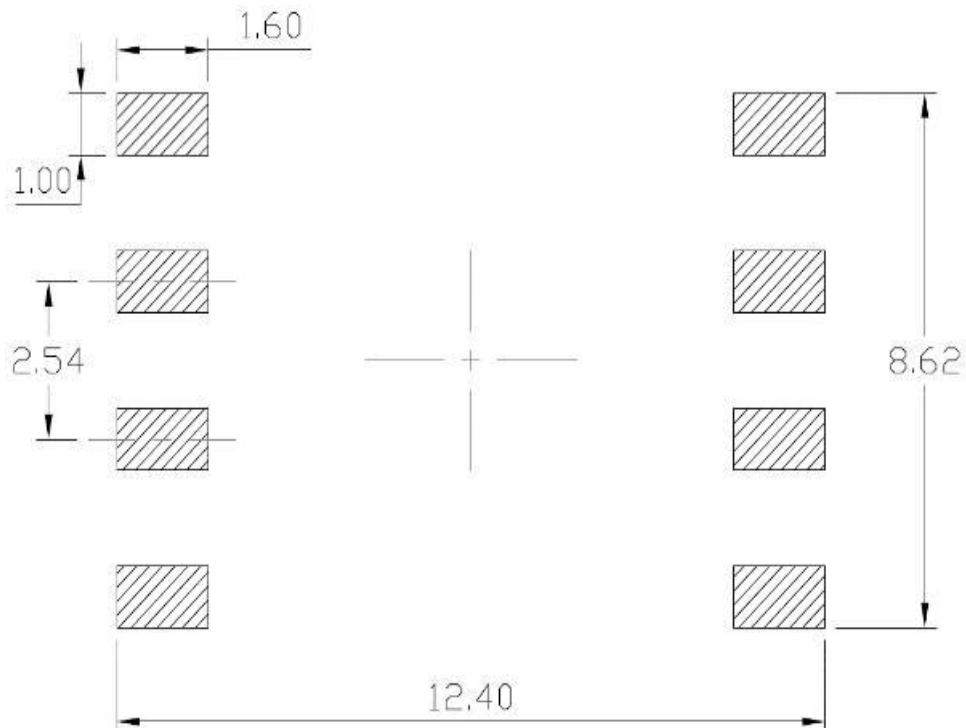


Recommended Solder Mask (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming

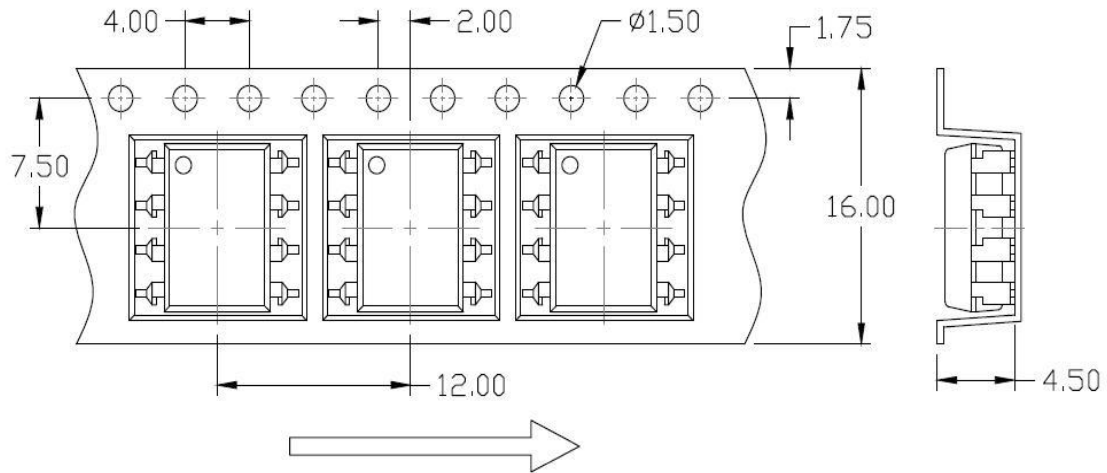


Surface Mount (Gullwing) Lead Forming

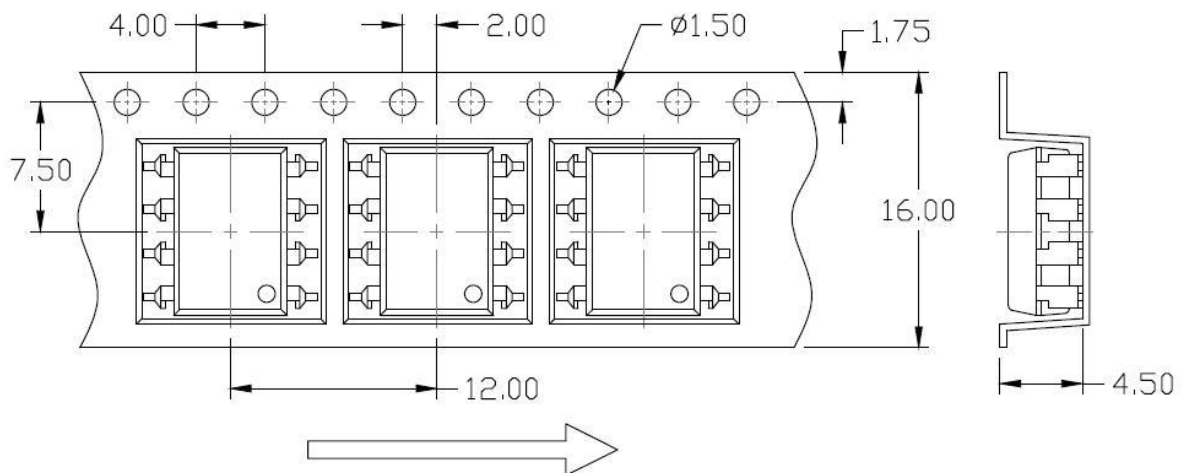


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T1)

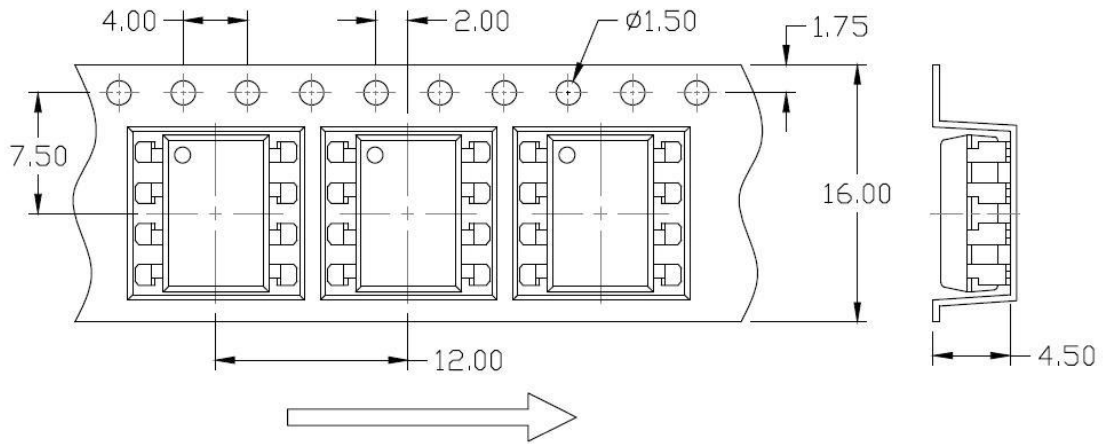


Option S(T2)

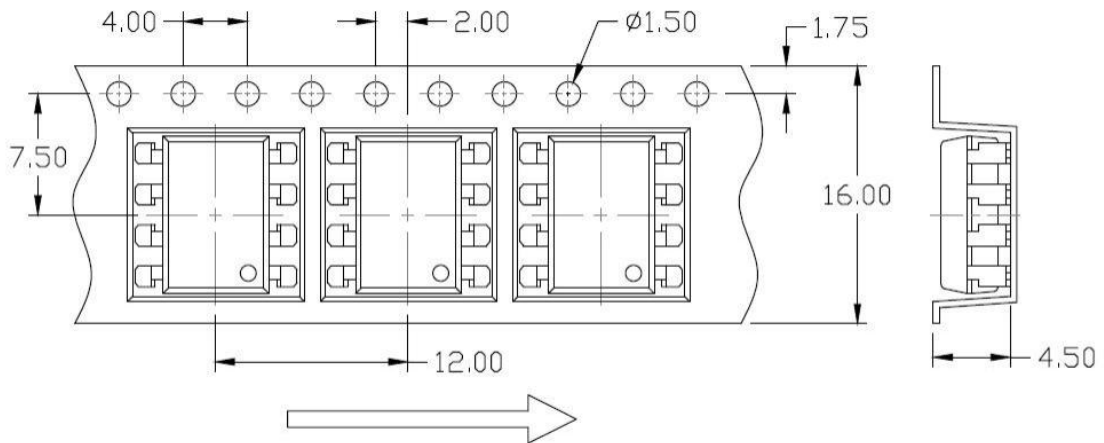


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option SL(T1)

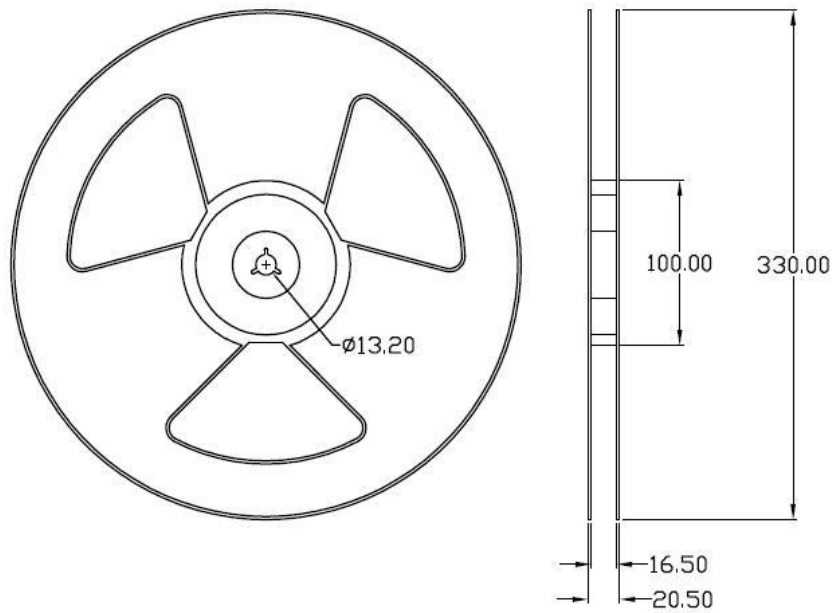


Option SL(T2)



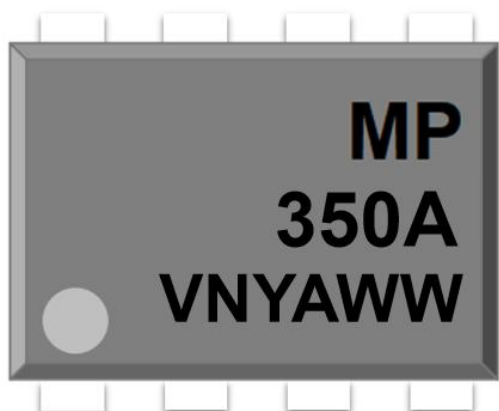
REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S & SL



ORDERING AND MARKING INFORMATION

MARKING INFORMATION



MP	: Company Abbr.
350A	: Part Number
V	: VDE Option (V or None)
N	:Customer Specified Option(1~9 or None)
Y	: Fiscal Year
A	: Manufacturing Code
WW	: Work Week

ORDERING INFORMATION

MP350A(Y)(Z)-GV(XN)

MP -Company Abbr.

350A -Part Number.

(Y) -Lead Form Option (M/S/SL/None).

(Z) -Tape and Reel Option (T1/T2).

G -Material Option (G: Green, None: Non-Green).

V -VDE Option (V or None).

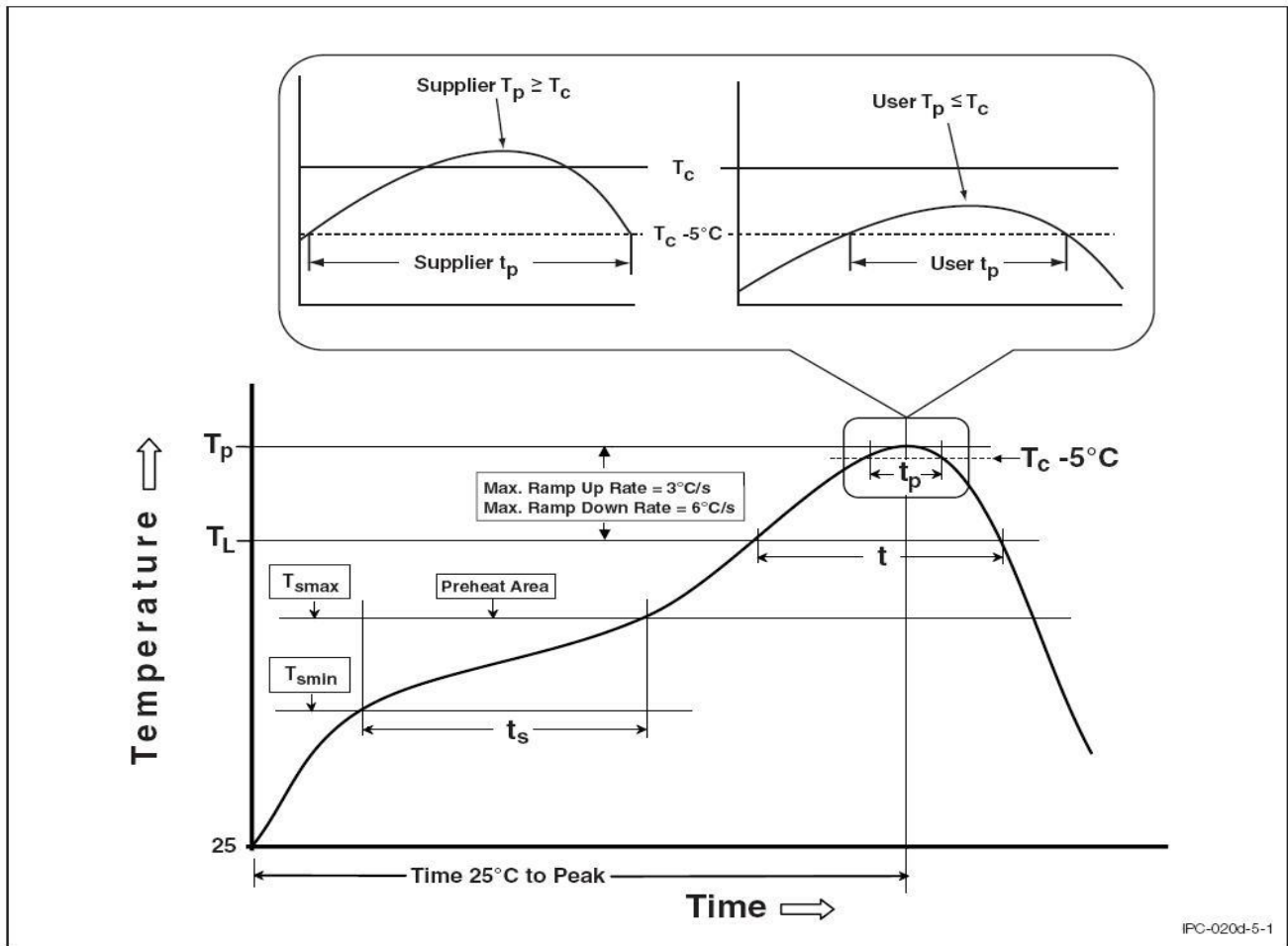
(XN)-Customer Specified Option (X: A~Z or None; N:1~9 or None).

PACKING QUANTITY

Option	Quantity	Quantity – Inner box	Quantity – Outer box
None	45 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box =14.4k Units
M	45 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box =14.4k Units
S(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
S(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units

REFLOW INFORMATION

REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	100	150°C
Temperature Max. (T _{smax})	150	200°C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second max.	3°C/second max.
Liquidous Temperature (T _L)	183°C	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



MP350A Series

DIP8, DC Input, 2.5A, Gate Driver Photo Coupler

DISCLAIMER

- Our company is continually improving the quality, reliability, function and design. Our company reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Immerge unit's body in solder paste is not recommended.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.

■ Revision History

Version	Date	Subjects (major changes since last revision)
0.1	2024-05-07	Datasheet Complete